

ZIITEK ELECTRONIC MATERIAL & TECHNOLOGY CO.,LTD

TIF®800HP Thermally Conductive Gap Filler Pads Series

REV03.1



TIF®800HP Series thermally conductive interface materials are applied to fill the air gaps between the heating elements and the heat dissipation fins or the metal base. Their flexibility and elasticity make them suited to coat very uneven surfaces. Heat can transmit to the metal housing or dissipation plate from the heating elements or even the entire PCB, which effectly enhances the efficiency and life-time of the heat-generating electronic components.

Features

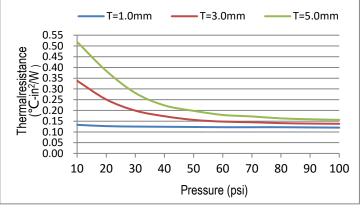
- Sood thermal conductivity
- » Naturally tacky needing no further adhesive coating
- Soft and Compressible for low stress applications
- » Available in varies thickness

Application

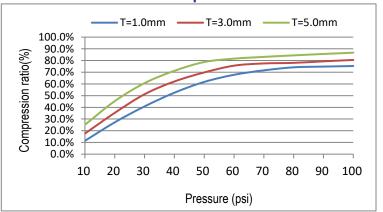
- » Cooling components to the chassis of frame
- Set Top Box
- » Car Battery & Power Supply
- » Charging Pile
- » LED TV/ Lighting
- » Graphics Card Thermal Module

Typical Properties of TIF [®] 800HP Series					
Property	Value	Test method			
Color	Gray	Visual			
Construction	Ceramic filled silicone elastomer	-			
Thickness range	0.030"(0.75mm)~0.200" (5.0mm)	ASTM D374			
Hardness (Shore 00 Thickness ≥ 0.75mm)	45	ASTM 2240			
Hardnes (Shore00 Thickness<0.75mm)	65	ASTM 2240			
Density (g/cm³)	3.55	ASTM D792			
Continuous Use Temp (°C)	-40~200	Ziitek Test Method			
Dielectric Breakdown Voltage (T=1.0mm, Vac)	≥5500	ASTM D149			
Dielectric Constant@1MHz	4.5	ASTM D150			
Volume Resistivity	≥1.0X10 ¹² Ohm-cm	ASTM D257			
Thermal Conductivity (W/mK)	12.0	ASTM D5470			
	12.0	ISO22007-2.2			
Flame Rating	V-0	UL 94			

Pressure. vs.Thermal Resistance



Pressure. vs. Compression Ratio



Product Thicknesses: 0.030-inch to 0.200-inch (0.75mm to 5.0mm) **Product Sizes:** 8" x 16"(203mm x406mm) Individual die cut shapesand and custom thickness can be supplied. Please contact us for confirming Safe disposal method does not require special protection. The storage condition is low temperature and dry, away from open fire and away from direct sunlight. For detailed method, please refer to the product material safety data sheet.

Thermally Conductive M	daterials Thermally Conductive Plastics	Heat Generating Materials	Shielding Materials	Foaming Silica Gel	Die-Cutting Products
Canada	Taiwan	Dongguan	Kuns	shan	Changsha
TEL: +001-604-2998559 E-mail: frances@ziitek.com.tw Http://www.thermazig.com	TEL: +886-2-22771007 E-mail: frances@ziitek.com.tw Http://www.ziitek.com.tw	TEL: +86-769-38801208 E-mail: frances@ziitek.c Http://www.ziitek.com	com.tw E-mail	86-512-57816297 : kelvin@ziitek.com /www.ziitek.com.cn	TEL: +86-731-86949836 E-mail: jor@ziitek.com Http://www.ziitek.com.cn

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